SMD Power Inductors
-YSPIT0660A Series

■ Features

- Molding Inductor.
- High reliability.
- High current，low DCR，high efficiency.
- Very low acoustic noise and very low leakage flux noise.
- Operating temperature:-55℃ ~ +125℃（Including self-temperature rise）.

■ Applications

- General Electronic.
- Video Device,TV,TFT.
- Power Module for PC.
- NB/Lap Top Computer.
- Server,VGA Card/Module.
- DC/DC converter.

■ Product Identification

YSPIT □□□□ – □□□ □

(1) (2) (3) (4)

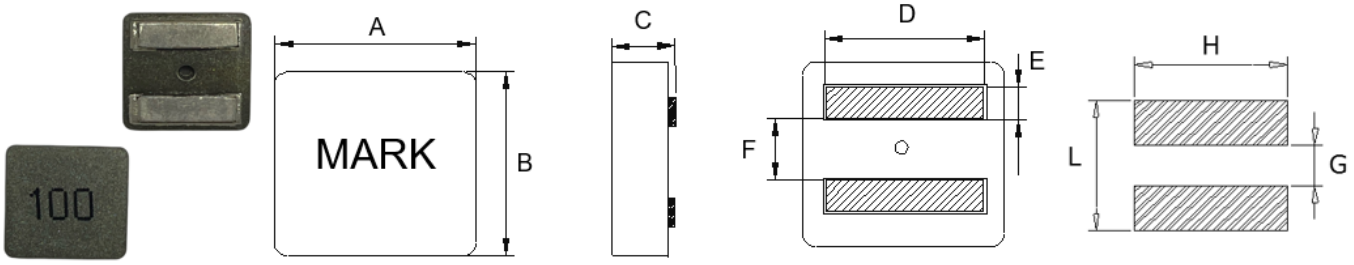
(1)： Type

(2)： Dimensions

(3)： Inductance value

(4)： Inductance Tolerance：N=±30%,M=±20%

■ Shapes and Dimensions (Unit：mm)



TYPE	A	B	C	D	E	F	G Ref.	H Ref.	L Ref.
YSPIT0660A	6.6±0.2	6.4±0.2	5.8±0.2	5.3±0.3	1.4±0.3	2.6±0.3	2.5	5.6	5.6

■ YSPIT0660A Series

Part Number	Inductance (uH) @100KHz/0.1V	DCR Max. (mΩ)	Saturation Current (A)		Heat Rating Current Typ.(A)	
			Max.	Typ.	20℃ rise	40℃ rise
YSPIT0660A-1R0M	1.0±20%	4.4	19.0	24.0	16.0	21.0
YSPIT0660A-1R5M	1.5±20%	6.1	15.0	20.0	13.5	17.5
YSPIT0660A-2R2M	2.2±20%	8.1	12.5	16.5	11.0	14.0
YSPIT0660A-3R3M	3.3±20%	12.3	11.0	13.0	9.0	12.0
YSPIT0660A-4R7M	4.7±20%	14.4	9.3	10.5	8.5	11.0
YSPIT0660A-5R6M	5.6±20%	15.9	8.7	9.9	7.6	10.0
YSPIT0660A-6R8M	6.8±20%	20.8	8.1	9.2	7.0	9.0
YSPIT0660A-8R2M	8.2±20%	26.4	8.0	8.4	6.0	8.0
YSPIT0660A-100M	10±20%	29.9	6.8	7.6	5.0	7.0
YSPIT0660A-150M	15±20%	43.8	5.0	5.8	4.5	6.0
YSPIT0660A-220M	22±20%	60.7	4.8	5.6	3.8	5.0

※ The saturation current value is the DC current value having inductance decrease down to 30%.(at 25℃)

※ The temperature rise current value is the DC current value having temperature increase up to 40℃. (at 25℃)

※ The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

■ Mechanical Reliability

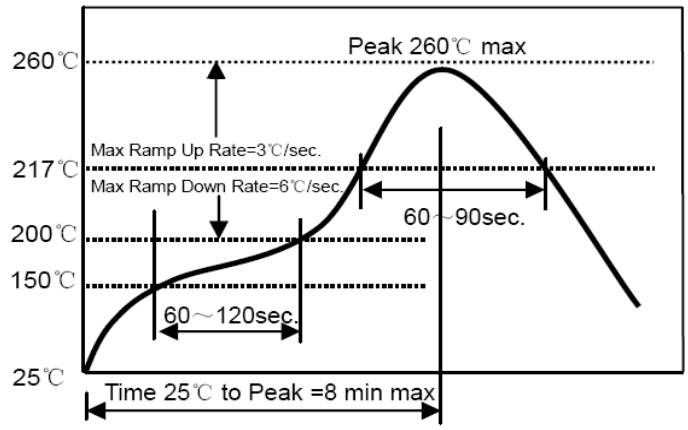
Item	Specification and Requirement	Test Method
Solderability	1. No case deformation or change in visual 2. New solder coverage More than 95%	1.Preheat：155℃±5℃ ， 60S±2S 2.Tin: lead-free. 3.Temperature:240℃±5℃， flux 3.0S±0.5S.
Mechanical shock	1. No case deformation or change in visual 2. △L/Lo≦±10%	1. Acceleration： 100G 2. Pulse time: ：6ms 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions
Mechanical vibration	1. No case deformation or change in visual 2. △L/Lo≦±10%	1. Reflow: 2times 2. Frequency: 10HZ ~ 50HZ ~ 10HZ， 20 Min/Cycles 3. Amplitude: 1.52 mm±10% 4. Directions: X,Y,Z 5. Time: 12 cycle / direction

■ Endurance Reliability

Item	Specification and Requirement	Test Method
Thermal Shock	Inductance change: Within ± 10% Without distinct damage in visual	1. First -55℃° for 30 minutes， last 125℃° for 30 minutes as 1 cycle. Go through 1000 cycles. 2. Max transfer time is 3 minutes. 3. Measured at room temperature after placing for 24±2 hours
Biased Humidity	Inductance change: Within ± 10% Without distinct damage in visual	1.Reflow 2 times, 2.85℃°±3℃°,85%±3%RH,1000 hours 3.Measured at room temperature after placing for 24±2 hours
Low temperature storage	Inductance change: Within ± 10% Without distinct damage in visual	1. Temperature：-55 ± 2℃° 2. Time：1000 hours 3. Measured at room temperature after placing for 24±2 hours
High temperature storage	Inductance change: Within ± 10% Without distinct damage in visual	1. Temperature：+125 ± 2℃° 2. Time：1000 hours 3. Measured at room temperature after placing for 24±2 hours

■ Recommended Soldering Technologies

Re-flowing Profile



Preheat condition: 150 ~200℃/60~120sec.

Allowed time above 217℃: 60~90sec.

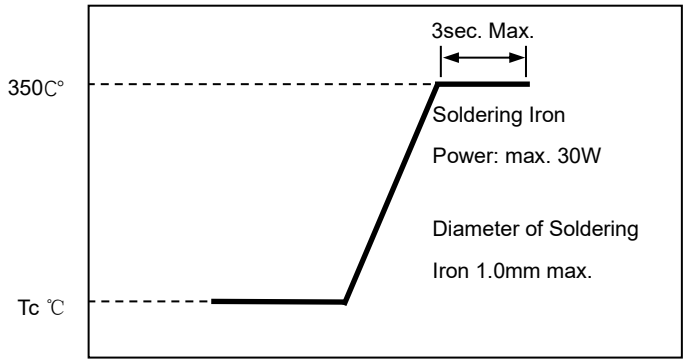
Peak temp: 260℃

Max time at Peak temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max

Iron Soldering Profile



Iron soldering power: Max. 30W

Pre-heating: 150℃/60sec.

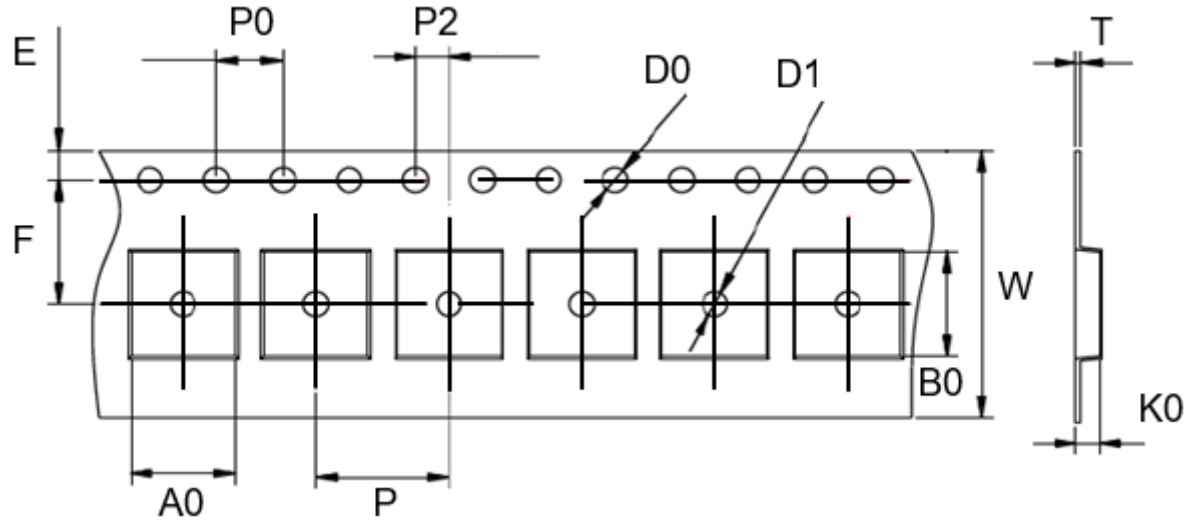
Soldering Tip temperature: 350℃ Max.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

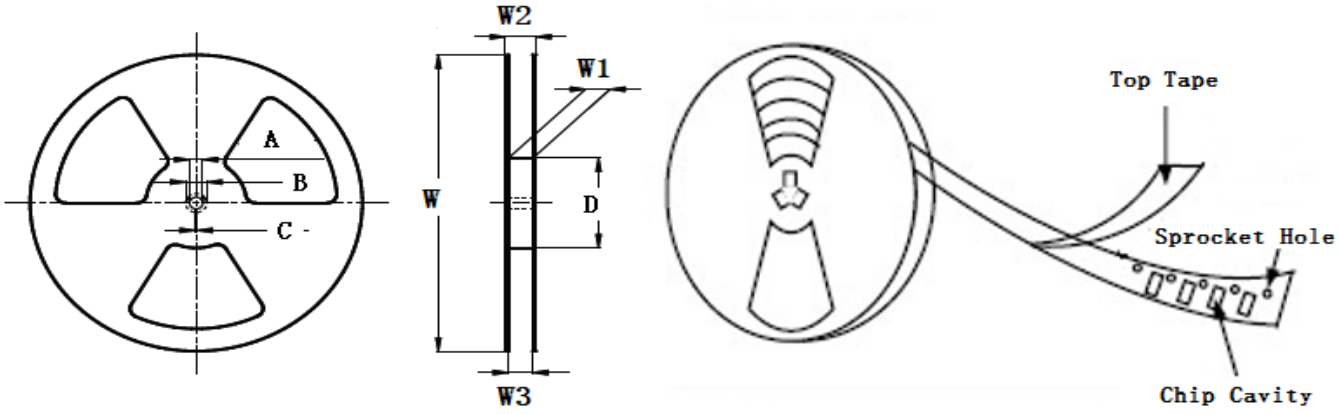
Max.1 times for iron soldering

■ Taping Dimensions(Unit:mm)



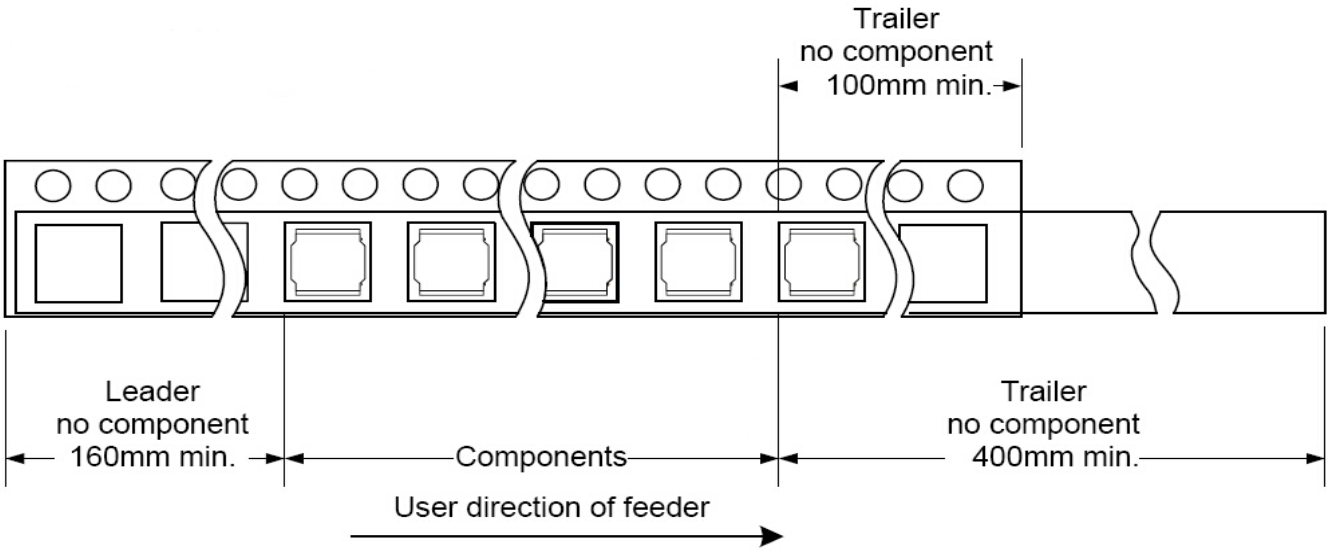
TYPE	W	P	P0	P2	D0	D1	T	A0	B0	K0	E	F	MPQ
YSPIT0660A	16 ±0.3	12 ±0.1	4 ±0.1	2 ±0.1	1.5 ±0.1	1.5 ±0.1	0.35 ±0.05	7.0 ±0.1	6.8 ±0.1	6.3 ±0.1	1.75 ±0.1	7.5 ±0.1	750

■ Reel Dimensions(Unit:mm)

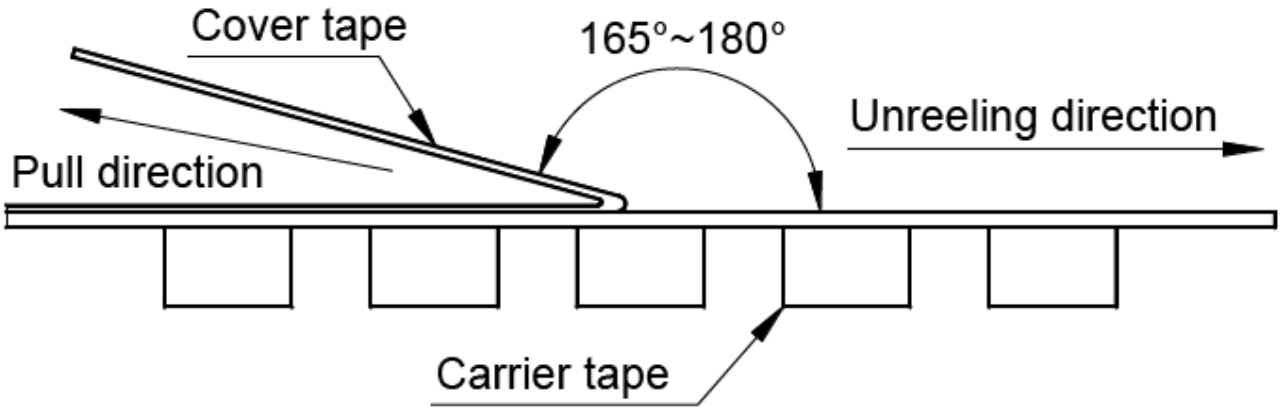


TYPE	W	W1	W2	W3	A	B	C	D
YSPIT0660A	330±2.0	16.4±2.0	22.4MAX	15.9 Min	13.0±0.5	21.0±0.8	2.0±0.5	97±0.5

■ Direction of rolling



■ Cover tape peel off condition



Cover tape peel force shall be 0.1N to 1.3N.

Reference peel speed 300±10mm/min.